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LM2727/LM2737 N-Channel FET Synchronous Buck Regulator Controller for Low Output Voltages **General Description**

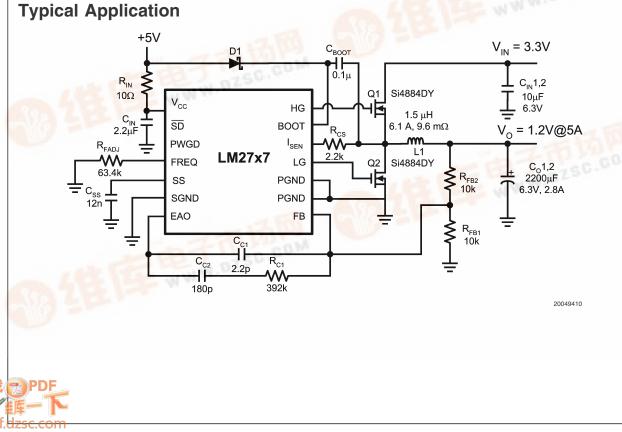
The LM2727 and LM2737 are high-speed, synchronous, switching regulator controllers. They are intended to control currents of 0.7A to 20A with up to 95% conversion efficiencies. The LM2727 employs output over-voltage and undervoltage latch-off. For applications where latch-off is not desired, the LM2737 can be used. Power up and down sequencing is achieved with the power-good flag, adjustable soft-start and output enable features. The LM2737 and LM2737 operate from a low-current 5V bias and can convert from a 2.2V to 16V power rail. Both parts utilize a fixedfrequency, voltage-mode, PWM control architecture and the switching frequency is adjustable from 50kHz to 2MHz by adjusting the value of an external resistor. Current limit is achieved by monitoring the voltage drop across the onresistance of the low-side MOSFET, which enhances low duty-cycle operation. The wide range of operating frequencies gives the power supply designer the flexibility to finetune component size, cost, noise and efficiency. The adaptive, non-overlapping MOSFET gate-drivers and high-side bootstrap structure helps to further maximize efficiency. The high-side power FET drain voltage can be from 2.2V to 16V and the output voltage is adjustable down to 0.6V.

Features

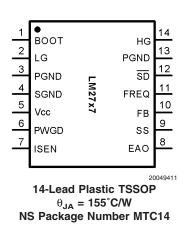
- Input power from 2.2V to 16V
- Output voltage adjustable down to 0.6V
- Power Good flag, adjustable soft-start and output enable for easy power sequencing
- Output over-voltage and under-voltage latch-off (LM2727)
- Output over-voltage and under-voltage flag (LM2737)
- Reference Accuracy: 1.5% (0°C 125°C)
- Current limit without sense resistor
- Soft start
- Switching frequency from 50 kHz to 2 MHz
- TSSOP-14 package

Applications

- Cable Modems
- Set-Top Boxes/ Home Gateways
- **DDR Core Power**
- High-Efficiency Distributed Power
- Local Regulation of Core Power



Connection Diagram



Pin Description

BOOT (Pin 1) - Supply rail for the N-channel MOSFET gate drive. The voltage should be at least one gate threshold above the regulator input voltage to properly turn on the high-side N-FET.

LG (Pin 2) - Gate drive for the low-side N-channel MOSFET. This signal is interlocked with HG to avoid shoot-through problems.

PGND (Pins 3, 13) - Ground for FET drive circuitry. It should be connected to system ground.

SGND (Pin 4) - Ground for signal level circuitry. It should be connected to system ground.

V_{cc} (Pin 5) - Supply rail for the controller.

PWGD (Pin 6) - Power Good. This is an open drain output. The pin is pulled low when the chip is in UVP, OVP, or UVLO mode. During normal operation, this pin is connected to V_{CC} or other voltage source through a pull-up resistor.

ISEN (Pin 7) - Current limit threshold setting. This sources a fixed 50μ A current. A resistor of appropriate value should be connected between this pin and the drain of the low-side FET.

EAO (Pin 8) - Output of the error amplifier. The voltage level on this pin is compared with an internally generated ramp signal to determine the duty cycle. This pin is necessary for compensating the control loop.

SS (Pin 9) - Soft start pin. A capacitor connected between this pin and ground sets the speed at which the output voltage ramps up. Larger capacitor value results in slower output voltage ramp but also lower inrush current.

FB (Pin 10) - This is the inverting input of the error amplifier, which is used for sensing the output voltage and compensating the control loop.

FREQ (Pin 11) - The switching frequency is set by connecting a resistor between this pin and ground.

 \overline{SD} (Pin 12) - IC Logic Shutdown. When this pin is pulled low the chip turns off the high side switch and turns on the low side switch. While this pin is low, the IC will not start up. An internal 20µA pull-up connects this pin to V_{CC}.

HG (Pin 14) - Gate drive for the high-side N-channel MOS-FET. This signal is interlocked with LG to avoid shootthrough problems.

Operating Ratings

Infrared or Convection (20sec)

ESD Rating

Supply Voltage (V_{CC}) Junction Temperature Range Thermal Resistance (θ_{JA}) 4.5V to 5.5V -40°C to +125°C 155°C/W

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

V _{cc}	7V
BOOTV	21V
Junction Temperature	150°C
Storage Temperature	–65°C to 150°C
Soldering Information	
Lead Temperature	
(soldering, 10sec)	260°C

Electrical Characteristics

 $V_{CC} = 5V$ unless otherwise indicated. Typicals and limits appearing in plain type apply for $T_A = T_J = +25$ °C. Limits appearing in boldface type apply over full Operating Temperature Range. Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
		$V_{CC} = 4.5V, 0^{\circ}C \text{ to } +125^{\circ}C$	0.591	0.6	0.609	
		$V_{CC} = 5V, 0^{\circ}C \text{ to } +125^{\circ}C$	0.591	0.6	0.609	1
		V _{CC} = 5.5V, 0°C to +125°C	0.591	0.6	0.609	1
V_{FB_ADJ}	FB Pin Voltage	V _{CC} = 4.5V, -40°C to +125°C	0.589	0.6	0.609	V
		$V_{\rm CC} = 5V, -40^{\circ}C \text{ to } +125^{\circ}C$	0.589	0.6	0.609	1
		V _{CC} = 5.5V, -40°C to +125°C	0.589	0.6	0.609	1
V _{ON}	UVLO Thresholds	Rising		4.2		v
		Falling		3.6		
		SD = 5V, FB = 0.55V	1	1.5	2	
	Operating V _{CC} Current	Fsw = 600kHz				m/
I_{Q-V5}		SD = 5V, FB = 0.65V	0.8	1.7	2.2	
		Fsw = 600kHz				
	Shutdown V _{CC} Current	SD = 0V	0.15	0.4	0.7	m/
t _{PWGD1}	PWGD Pin Response Time	FB Voltage Going Up		6		μs
t _{PWGD2}	PWGD Pin Response Time	FB Voltage Going Down		6		μs
I _{SD}	SD Pin Internal Pull-up Current			20		μA
I _{SS-ON}	SS Pin Source Current	SS Voltage = 2.5V				
		0°C to +125°C	8	11	15	μA
		-40°C to +125°C	5	11	15	
I _{SS-OC}	SS Pin Sink Current During Over Current	SS Voltage = 2.5V		95		μΑ
	I _{SEN} Pin Source Current Trip	0°C to +125°C	35	50	65	
I _{SEN-TH}	Point	-40°C to +125°C	28	50	65	μA
ROR AMP	LIFIER					
GBW	Error Amplifier Unity Gain Bandwidth			5		МН
G	Error Amplifier DC Gain			60		dB
SR	Error Amplifier Slew Rate			6		
I _{FB}	FB Pin Bias Current	FB = 0.55V	0	15	100	
		FB = 0.65V	0	30	155	nA
I _{EAO}	EAO Pin Current Sourcing and	V _{EAO} = 2.5, FB = 0.55V		2.8		
	Sinking	V _{EAO} = 2.5, FB = 0.65V		0.8		m/
V _{EA}	Error Amplifier Maximum Swing	Minimum		1.2		
		Maximum		3.2		V

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LM2727/LM2737

235°C 2 kV

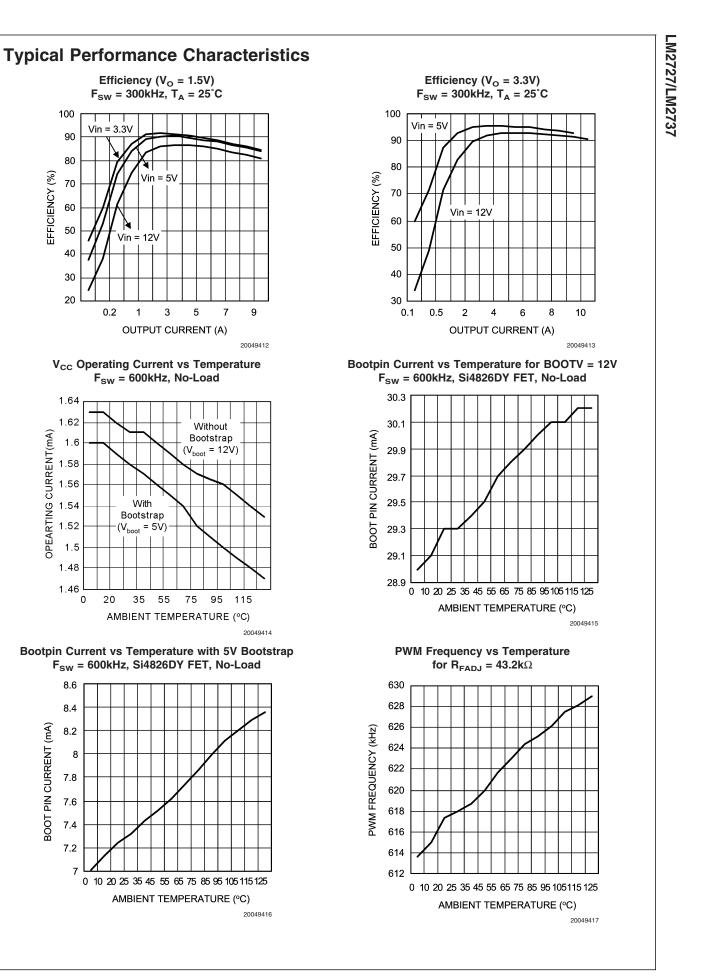
Electrical Characteristics (Continued)

 $V_{CC} = 5V$ unless otherwise indicated. Typicals and limits appearing in plain type apply for $T_A = T_J = +25$ °C. Limits appearing in boldface type apply over full Operating Temperature Range. Datasheet min/max specification limits are guaranteed by design, test, or statistical analysis.

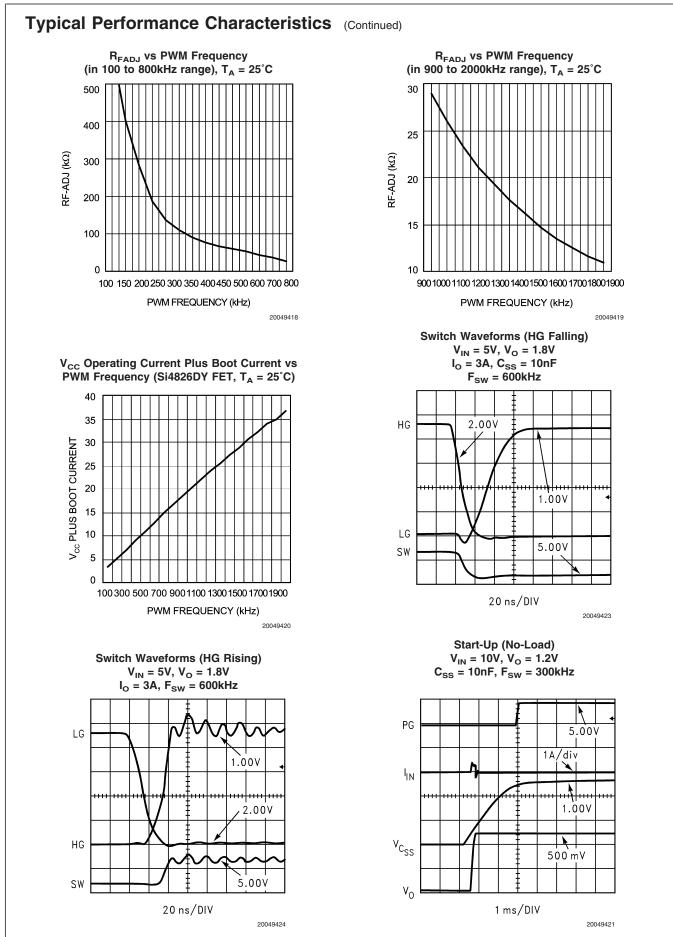
Symbol	Parameter	Conditions	Min	Тур	Max	Units
GATE DRIVE	E		•			
I _{Q-BOOT}	BOOT Pin Quiescent Current	BOOTV = 12V, EN = 0				
		0°C to +125°C		95	160	μA
		-40°C to +125°C		95	215	
R _{DS1}	Top FET Driver Pull-Up ON resistance	BOOT-SW = 5V@350mA		3		Ω
R_{DS2}	Top FET Driver Pull-Down ON resistance	BOOT-SW = 5V@350mA		2		Ω
R_{DS3}	Bottom FET Driver Pull-Up ON resistance	BOOT-SW = 5V@350mA		3		Ω
R_{DS4}	Bottom FET Driver Pull-Down ON resistance	BOOT-SW = 5V@350mA		2		Ω
OSCILLATO	R					
		$R_{FADJ} = 590 k\Omega$		50		
		$R_{FADJ} = 88.7 k\Omega$		300		
		$R_{FADJ} = 42.2k\Omega, 0^{\circ}C \text{ to } +125^{\circ}C$	500	600	700	 kHz
f _{osc}	PWM Frequency	$R_{FADJ} = 42.2k\Omega$, -40°C to +125°C	490	600	700	
		$R_{FADJ} = 17.4 k\Omega$		1400		1
		$R_{FADJ} = 11.3k\Omega$		2000		1
D	Max Duty Cycle	f _{PWM} = 300kHz		90		%
		f _{PWM} = 600kHz		88		
LOGIC INPU	TS AND OUTPUTS		-			
V_{SD-IH}	SD Pin Logic High Trip Point			2.6	3.5	V
V_{SD-IL}	SD Pin Logic Low Trip Point	0°C to +125°C	1.3	1.6		v
		-40°C to +125°C	1.25	1.6		v
V _{PWGD-TH-LO}	PWGD Pin Trip Points	FB Voltage Going Down				
		0°C to +125°C	0.413	0.430	0.446	V
		-40°C to +125°C	0.410	0.430	0.446	
V _{PWGD-TH-HI}	PWGD Pin Trip Points	FB Voltage Going Up				
		0°C to +125°C	0.691	0.710	0.734	V
		-40°C to +125°C	0.688	0.710	0.734	
$V_{PWGD-HYS}$	PWGD Hysteresis (LM2737 only)	FB Voltage Going Down FB Voltage		35		mv
		Going Up		110		

Note 1: Absolute maximum ratings indicate limits beyond which damage to the device may occur. Operating ratings indicate conditions for which the device operates correctly. Opearting Ratings do not imply guaranteed performance limits.

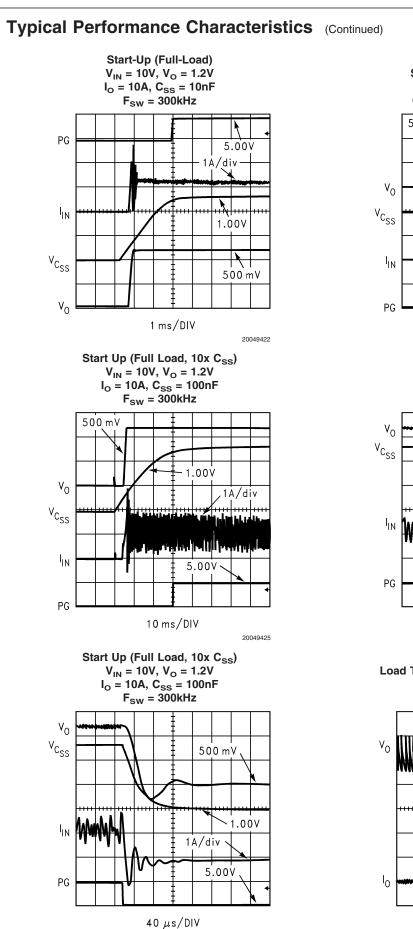
Note 2: The human body model is a 100pF capacitor discharged through a 1.5k resistor into each pin.

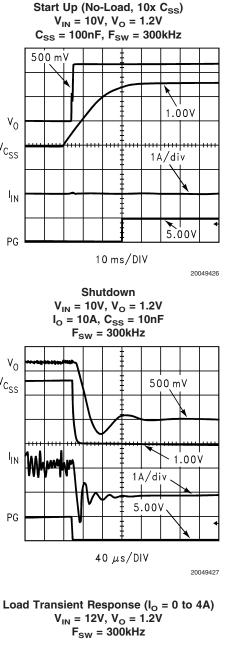


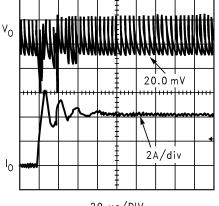




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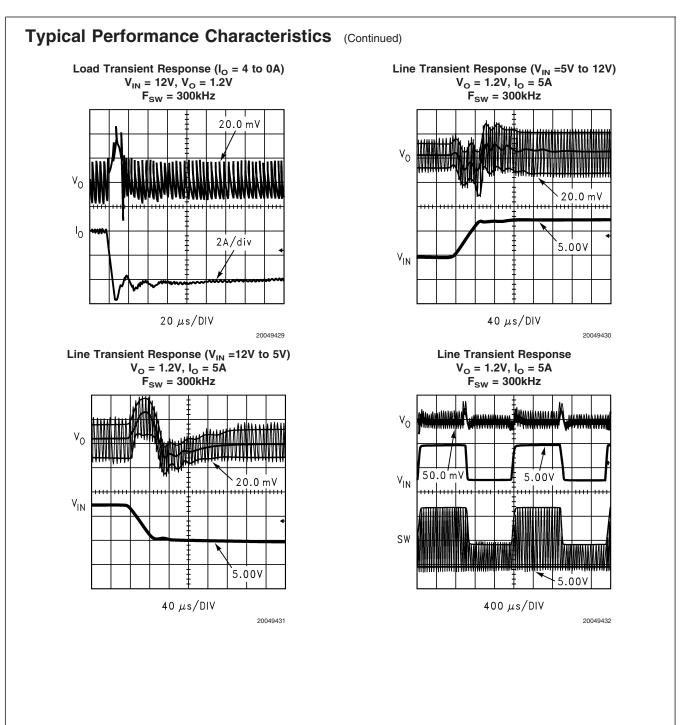


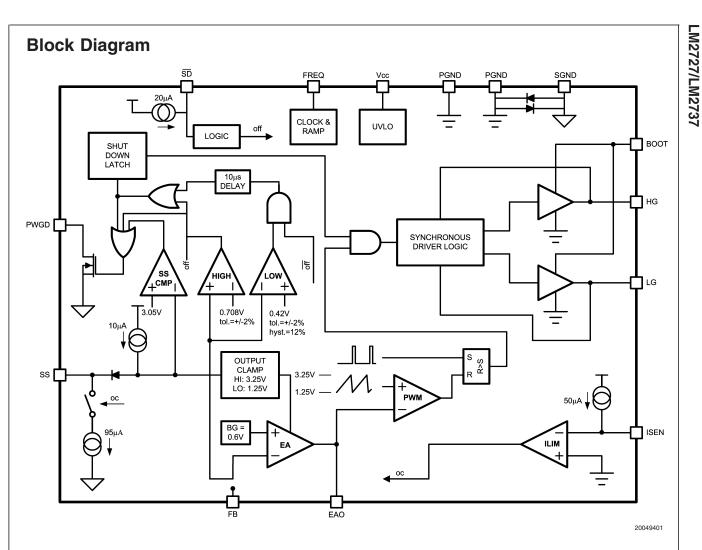




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Application Information

THEORY OF OPERATION

The LM2727 is a voltage-mode, high-speed synchronous buck regulator with a PWM control scheme. It is designed for use in set-top boxes, thin clients, DSL/Cable modems, and other applications that require high efficiency buck converters. It has power good (PWRGD), output shutdown (SD), over voltage protection (OVP) and under voltage protection (UVP). The over-voltage and under-voltage signals are OR gated to drive the Power Good signal and a shutdown latch, which turns off the high side gate and turns on the low side gate if pulled low. Current limit is achieved by sensing the voltage V_{DS} across the low side FET. During current limit the high side gate is turned off and the low side gate turned on. The soft start capacitor is discharged by a 95µA source (reducing the maximum duty cycle) until the current is under control. The LM2737 does not latch off during UVP or OVP, and uses the HIGH and LOW comparators for the powergood function only.

START UP

When V_{CC} exceeds 4.2V and the enable pin EN sees a logic high the soft start capacitor begins charging through an internal fixed 10µA source. During this time the output of the error amplifier is allowed to rise with the voltage of the soft start capacitor. This capacitor, Css, determines soft start time, and can be determined approximately by:

 $C_{ss} = \frac{t_{ss}}{2.5 \times 10^5}$

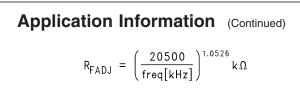
An application for a microprocessor might need a delay of 3ms, in which case C_{SS} would be 12nF. For a different device, a 100ms delay might be more appropriate, in which case C_{SS} would be 400nF. (390 10%) During soft start the PWRGD flag is forced low and is released when the voltage reaches a set value. At this point this chip enters normal operation mode, the Power Good flag is released, and the OVP and UVP functions begin to monitor Vo.

NORMAL OPERATION

While in normal operation mode, the LM2727/37 regulates the output voltage by controlling the duty cycle of the high side and low side FETs. The equation governing output voltage is:

$$0.6 = \frac{R_{FB1}}{R_{FB1} + R_{FB2}} V_{o}$$

The PWM frequency is adjustable between 50kHz and 2MHz and is set by an external resistor, R_{FADJ} , between the FREQ pin and ground. The resistance needed for a desired frequency is approximately:



MOSFET GATE DRIVERS

The LM2727/37 has two gate drivers designed for driving N-channel MOSFETs in a synchronous mode. Power for the drivers is supplied through the BOOTV pin. For the high side gate (HG) to fully turn on the top FET, the BOOTV voltage must be at least one $V_{GS(th)}$ greater than Vin. (BOOTV \geq 2*Vin) This voltage can be supplied by a separate, higher voltage source, or supplied from a local charge pump structure. In a system such as a desktop computer, both 5V and 12V are usually available. Hence if Vin was 5V, the 12V supply could be used for BOOTV. 12V is more than 2*Vin, so the HG would operate correctly. For a BOOTV of 12V, the initial gate charging current is 2A, and the initial gate discharging current is typically 6A.

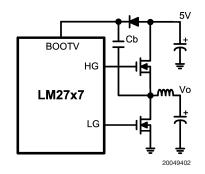


FIGURE 1. BOOTV Supplied by Charge Pump

In a system without a separate, higher voltage, a charge pump (bootstrap) can be built using a diode and small capacitor, *Figure 1*. The capacitor serves to maintain enough voltage between the top FET gate and source to control the device even when the top FET is on and its source has risen up to the input voltage level.

The LM2727/37 gate drives use a BiCMOS design. Unlike some other bipolar control ICs, the gate drivers have rail-torail swing, ensuring no spurious turn-on due to capacitive coupling.

POWER GOOD SIGNAL

The power good signal is the or-gated flag representing over-voltage and under-voltage protection. If the output voltage is 18% over it's nominal value, $V_{FB} = 0.7V$, or falls 30% below that value, $V_{FB} = 0.41V$, the power good flag goes low. The converter then turns off the high side gate, and turns on the low side gate. Unlike the output (LM2727 only) the power good flag is not latched off. It will return to a logic high whenever the feedback pin voltage is between 70% and 118% of 0.6V.

UVLO

The 4.2V turn-on threshold on V_{CC} has a built in hysteresis of 0.6V. Therefore, if V_{CC} drops below 3.6V, the chip enters UVLO mode. UVLO consists of turning off the top FET, turning on the bottom FET, and remaining in that condition

until $V_{\rm CC}$ rises above 4.2V. As with shutdown, the soft start capacitor is discharged through a FET, ensuring that the next start-up will be smooth.

CURRENT LIMIT

Current limit is realized by sensing the voltage across the low side FET while it is on. The $R_{\rm DSON}$ of the FET is a known value, hence the current through the FET can be determined as:

$V_{DS} = I * R_{DSON}$

The current limit is determined by an external resistor, R_{CS}, connected between the switch node and the ISEN pin. A constant current of 50µA is forced through Rcs, causing a fixed voltage drop. This fixed voltage is compared against V_{DS} and if the latter is higher, the current limit of the chip has been reached. R_{CS} can be found by using the following:

$$R_{CS} = R_{DSON}(LOW) * I_{LIM}/50\mu A$$

For example, a conservative 15A current limit in a 10A design with a minimum $R_{\rm DSON}$ of $10m\Omega$ would require a $3.3k\Omega$ resistor. Because current sensing is done across the low side FET, no minimum high side on-time is necessary. In the current limit mode the LM2727/37 will turn the high side off and the keep low side on for as long as necessary. The chip also discharges the soft start capacitor through a fixed 95\muA source. In this way, smooth ramping up of the output voltage as with a normal soft start is ensured. The output of the LM2727/37 internal error amplifier is limited by the voltage on the soft start capacitor. Hence, discharging the soft start capacitor reduces the maximum duty cycle D of the controller. During severe current limit, this reduction in duty cycle will reduce the output voltage, if the current limit conditions lasts for an extended time.

During the first few nanoseconds after the low side gate turns on, the low side FET body diode conducts. This causes an additional 0.7V drop in $V_{\rm DS}$. The range of $V_{\rm DS}$ is normally much lower. For example, if $R_{\rm DSON}$ were $10m\Omega$ and the current through the FET was 10A, $V_{\rm DS}$ would be 0.1V. The current limit would see 0.7V as a 70A current and enter current limit immediately. Hence current limit is masked during the time it takes for the high side switch to turn off and the low side switch to turn on.

UVP/OVP

The output undervoltage protection and overvoltage protection mechanisms engage at 70% and 118% of the target output voltage, respectively. In either case, the LM2727 will turn off the high side switch and turn on the low side switch, and discharge the soft start capacitor through a MOSFET switch. The chip remains in this state until the shutdown pin has been pulled to a logic low and then released. The UVP function is masked only during the first charging of the soft start capacitor, when voltage is first applied to the V_{CC} pin. In contrast, the LM2737 is designed to continue operating during UVP or OVP conditions, and to resume normal operation once the fault condition is cleared. As with the LM2727, the powergood flag goes low during this time, giving a logic-level warning signal.

SHUT DOWN

If the shutdown pin SD is pulled low, the LM2727/37 discharges the soft start capacitor through a MOSFET switch. The high side switch is turned off and the low side switch is turned on. The LM2727/37 remains in this state until $\overline{\text{SD}}$ is released.

Application Information (Continued)

DESIGN CONSIDERATIONS

The following is a design procedure for all the components needed to create the circuit shown in *Figure 3* in the Example Circuits section, a 5V in to 1.2V out converter, capable of delivering 10A with an efficiency of 85%. The switching frequency is 300kHz. The same procedures can be followed to create the circuit shown in *Figure 3*, *Figure 4*, and to create many other designs with varying input voltages, output voltages, and output currents.

INPUT CAPACITOR

The input capacitors in a Buck switching converter are subjected to high stress due to the input current waveform, which is a square wave. Hence input caps are selected for their ripple current capability and their ability to withstand the heat generated as that ripple current runs through their ESR. Input rms ripple current is approximately:

$$I_{rms_rip} = I_0 * \sqrt{D(1 - D)}$$

The power dissipated by each input capacitor is:

$$P_{\rm D} = \frac{l_{\rm rms_rip}^2 * \rm ESR}{n^2}$$

Here, n is the number of capacitors, and indicates that power loss in each cap decreases rapidly as the number of input caps increase. The worst-case ripple for a Buck converter occurs during full load, when the duty cycle D = 50%.

In the 5V to 1.2V case, D = 1.2/5 = 0.24. With a 10A maximum load the ripple current is 4.3A. The Sanyo 10MV5600AX aluminum electrolytic capacitor has a ripple current rating of 2.35A, up to 105°C. Two such capacitors make a conservative design that allows for unequal current sharing between individual caps. Each capacitor has a maximum ESR of 18m Ω at 100 kHz. Power loss in each device is then 0.05W, and total loss is 0.1W. Other possibilities for input and output capacitors include MLCC, tantalum, OSCON, SP, and POSCAPS.

INPUT INDUCTOR

The input inductor serves two basic purposes. First, in high power applications, the input inductor helps insulate the input power supply from switching noise. This is especially important if other switching converters draw current from the same supply. Noise at high frequency, such as that developed by the LM2727 at 1MHz operation, could pass through the input stage of a slower converter, contaminating and possibly interfering with its operation.

An input inductor also helps shield the LM2727 from high frequency noise generated by other switching converters. The second purpose of the input inductor is to limit the input current slew rate. During a change from no-load to full-load, the input inductor sees the highest voltage change across it, equal to the full load current times the input capacitor ESR. This value divided by the maximum allowable input current slew rate gives the minimum input inductance:

$$L_{in} = \frac{\Delta V}{\left(\frac{di}{dt}\right)_{max}}$$

In the case of a desktop computer system, the input current slew rate is the system power supply or "silver box" output current slew rate, which is typically about 0.1A/µs. Total input capacitor ESR is $9m\Omega$, hence ΔV is $10^*0.009 = 90$ mV, and the minimum inductance required is 0.9μ H. The input inductor should be rated to handle the DC input current, which is approximated by:

$$I_{\rm IN-DC} = \frac{I_0 * D}{\eta}$$

In this case I_{IN-DC} is about 2.8A. One possible choice is the TDK SLF12575T-1R2N8R2, a 1.2µH device that can handle 8.2Arms, and has a DCR of 7m Ω .

OUTPUT INDUCTOR

The output inductor forms the first half of the power stage in a Buck converter. It is responsible for smoothing the square wave created by the switching action and for controlling the output current ripple. (ΔI_o) The inductance is chosen by selecting between tradeoffs in efficiency and response time. The smaller the output inductor, the more quickly the converter can respond to transients in the load current. As shown in the efficiency calculations, however, a smaller inductor requires a higher switching frequency to maintain the same level of output current ripple. An increase in frequency can mean increasing loss in the FETs due to the charging and discharging of the gates. Generally the switching frequency is chosen so that conduction loss outweighs switching loss. The equation for output inductor selection is:

$$L = \frac{V_{in} - V_0}{\Delta i_0 * F_{SW}} * D$$

Plugging in the values for output current ripple, input voltage, output voltage, switching frequency, and assuming a 40% peak-to-peak output current ripple yields an inductance of 1.5µH. The output inductor must be rated to handle the peak current (also equal to the peak switch current), which is (lo + $0.5^*\Delta I_0$). This is 12A for a 10A design. The Coilcraft D05022-152HC is 1.5µH, is rated to 15Arms, and has a DCR of 4m Ω .

OUTPUT CAPACITOR

The output capacitor forms the second half of the power stage of a Buck switching converter. It is used to control the output voltage ripple (ΔV_o) and to supply load current during fast load transients.

In this example the output current is 10A and the expected type of capacitor is an aluminum electrolytic, as with the input capacitors. (Other possibilities include ceramic, tantalum, and solid electrolyte capacitors, however the ceramic type often do not have the large capacitance needed to supply current for load transients, and tantalums tend to be more expensive than aluminum electrolytic.) Aluminum capacitors tend to have very high capacitance and fairly low ESR, meaning that the ESR zero, which affects system stability, will be much lower than the switching frequency. The large capacitance means that at switching frequency, the ESR is dominant, hence the type and number of output capacitors is selected on the basis of ESR. One simple formula to find the maximum ESR based on the desired output voltage ripple, ΔV_o and the designed output current ripple, ΔI_o , is:

Application Information (Continued) $ESR_{MAX} = \frac{\Delta V_{o}}{\Delta I_{o}}$

In this example, in order to maintain a 2% peak-to-peak output voltage ripple and a 40% peak-to-peak inductor current ripple, the required maximum ESR is $6m\Omega$. Three Sanyo 10MV5600AX capacitors in parallel will give an equivalent ESR of $6m\Omega$. The total bulk capacitance of 16.8mF is enough to supply even severe load transients. Using the same capacitors for both input and output also keeps the bill of materials simple.

MOSFETS

MOSFETS are a critical part of any switching controller and have a direct impact on the system efficiency. In this case the target efficiency is 85% and this is the variable that will determine which devices are acceptable. Loss from the capacitors, inductors, and the LM2727 itself are detailed in the Efficiency section, and come to about 0.54W. To meet the target efficiency, this leaves 1.45W for the FET conduction loss, gate charging loss, and switching loss. Switching loss is particularly difficult to estimate because it depends on many factors. When the load current is more than about 1 or 2 amps, conduction losses outweigh the switching and gate charging losses. This allows FET selection based on the R_{DSON} of the FET. Adding the FET switching and gate charging losses to the equation leaves 1.2W for conduction losses. The equation for conduction loss is:

$$P_{Cnd} = D(I_{o}^{2} * R_{DSON} * k) + (1-D)(I_{o}^{2} * R_{DSON} * k)$$

The factor k is a constant which is added to account for the increasing R_{DSON} of a FET due to heating. Here, k = 1.3. The Si4442DY has a typical R_{DSON} of 4.1m Ω . When plugged into the equation for P_{CND} the result is a loss of 0.533W. If this design were for a 5V to 2.5V circuit, an equal number of FETs on the high and low sides would be the best solution. With the duty cycle D = 0.24, it becomes apparent that the low side FET carries the load current 76% of the time. Adding a second FET in parallel to the bottom FET could improve the efficiency by lowering the effective R_{DSON} . The lower the duty cycle, the more effective a second or even third FET can be. For a minimal increase in gate charging loss (0.054W) the decrease in conduction loss is 0.15W. What was an 85% design improves to 86% for the added cost of one SO-8 MOSFET.

CONTROL LOOP COMPONENTS

The circuit is this design example and the others shown in the Example Circuits section have been compensated to improve their DC gain and bandwidth. The result of this compensation is better line and load transient responses. For the LM2727, the top feedback divider resistor, Rfb2, is also a part of the compensation. For the 10A, 5V to 1.2V design, the values are:

Cc1 = 4.7pF 10%, Cc2 = 1nF 10%, Rc = 229k Ω 1%. These values give a phase margin of 63° and a bandwidth of 29.3kHz.

SUPPORT CAPACITORS AND RESISTORS

The Cinx capacitors are high frequency bypass devices, designed to filter harmonics of the switching frequency and input noise. Two 1μ F ceramic capacitors with a sufficient voltage rating (10V for the Circuit of *Figure 3*) will work well in almost any case.

Rbypass and Cbypass are standard filter components designed to ensure smooth DC voltage for the chip supply and for the bootstrap structure, if it is used. Use 10Ω for the resistor and a 2.2µF ceramic for the cap. Cb is the bootstrap capacitor, and should be 0.1μ F. (In the case of a separate, higher supply to the BOOTV pin, this 0.1μ F cap can be used to bypass the supply.) Using a Schottky device for the bootstrap diode allows the minimum drop for both high and low side drivers. The On Semiconductor BAT54 or MBR0520 work well.

Rp is a standard pull-up resistor for the open-drain power good signal, and should be $10k\Omega$. If this feature is not necessary, it can be omitted.

 R_{CS} is the resistor used to set the current limit. Since the design calls for a peak current magnitude (Io + 0.5 * ΔI_o) of 12A, a safe setting would be 15A. (This is well below the saturation current of the output inductor, which is 25A.) Following the equation from the Current Limit section, use a $3.3 k \Omega$ resistor.

 ${\sf R}_{\sf FADJ}$ is used to set the switching frequency of the chip. Following the equation in the Theory of Operation section, the closest 1% tolerance resistor to obtain ${\sf f}_{\sf SW}$ = 300kHz is 88.7k Ω .

 $\rm C_{SS}$ depends on the users requirements. Based on the equation for $\rm C_{SS}$ in the Theory of Operation section, for a 3ms delay, a 12nF capacitor will suffice.

EFFICIENCY CALCULATIONS

A reasonable estimation of the efficiency of a switching controller can be obtained by adding together the loss is each current carrying element and using the equation:

$$\eta = \frac{P_o}{P_o + P_{total-loss}}$$

The following shows an efficiency calculation to complement the Circuit of *Figure 3*. Output power for this circuit is $1.2V \times 10A = 12W$.

Chip Operating Loss

 $P_{IQ} = I_{Q-V_{CC}} * V_{CC}$

2mA x 5V = 0.01W

FET Gate Charging Loss

$$P_{GC} = n * V_{CC} * Q_{GS} * f_{OSC}$$

The value n is the total number of FETs used. The Si4442DY has a typical total gate charge, Q_{GS} , of 36nC and an r_{ds-on} of 4.1m Ω . For a single FET on top and bottom: $2*5*36E^{-9*}300,000 = 0.108W$

FET Switching Loss

$$P_{SW} = 0.5 * V_{in} * I_{O} * (t_r + t_f) * f_{OSC}$$

The Si4442DY has a typical rise time t_r and fall time t_f of 11 and 47ns, respectively. $0.5^{*}5^{*}10^{*}58E^{-9*}300,000$ = 0.435W

Application Information (Continued)

FET Conduction Loss

 $P_{Cn} = 0.533W$

Input Capacitor Loss

$$P_{Cin} = \frac{I_{rms-rip}^2 * ESR}{n}$$

$$I_{rms-rip} = I_o^* \sqrt{D(1 - D)}$$

4.28²*0.018/2 = 0.084W

Example Circuits

Input Inductor Loss
$$P_{Lin} = I_{in}^2 * DCR_{input-L}$$

$$I_{\rm IN} = \frac{I_{\rm o} * D}{\eta_{\rm est'd}}$$

2.82²*0.007 = 0.055W

Output Inductor Loss

 $\mathsf{P}_{\mathsf{Lout}} = \mathsf{I}_{o}^2 * \mathsf{DCR}_{\mathsf{output-L}}$ $10^2 * 0.004 = 0.4\mathsf{W}$

System Efficiency

$$\frac{12}{12 + 1.625} = 88\%$$

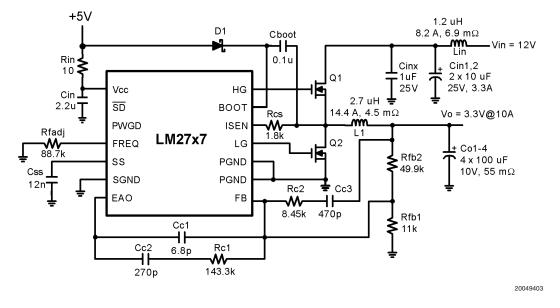


FIGURE 2. 5V-16V to 3.3V, 10A, 300kHz

This circuit and the one featured on the front page have been designed to deliver high current and high efficiency in a small package, both in area and in height The tallest component in

this circuit is the inductor L1, which is 6mm tall. The compensation has been designed to tolerate input voltages from 5 to 16V.

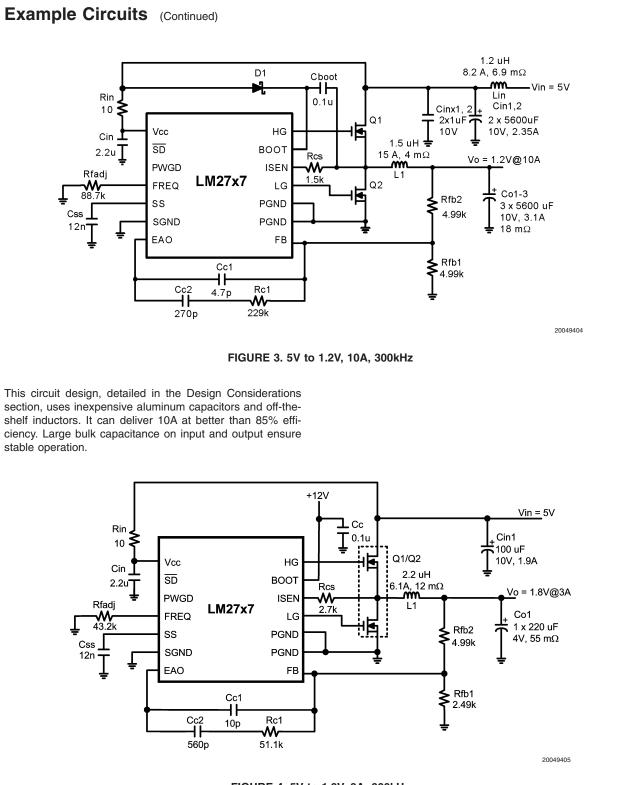
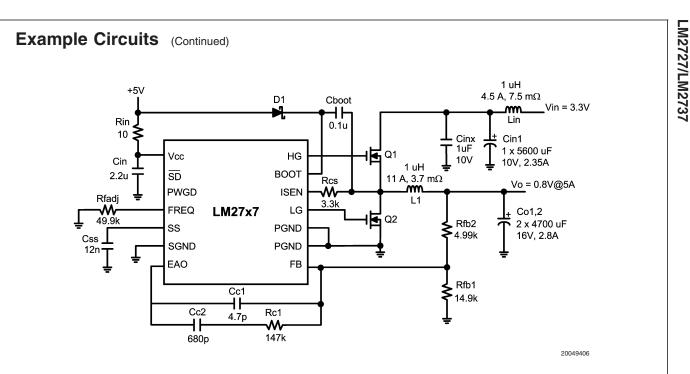


FIGURE 4. 5V to 1.8V, 3A, 600kHz

The example circuit of *Figure 4* has been designed for minimum component count and overall solution size. A switching frequency of 600kHz allows the use of small input/ output capacitors and a small inductor. The availability of separate 5V and 12V supplies (such as those available from desk-top computer supplies) and the low current further

reduce component count. Using the 12V supply to power the MOSFET drivers eliminates the bootstrap diode, D1. At low currents, smaller FETs or dual FETs are often the most efficient solutions. Here, the Si4826DY, an asymmetric dual FET in an SO-8 package, yields 92% efficiency at a load of 2A.





The circuit of *Figure 5* demonstrates the LM2727 delivering a low output voltage at high efficiency (87%) A separate 5V supply is required to run the chip, however the input voltage can be as low as 2.2

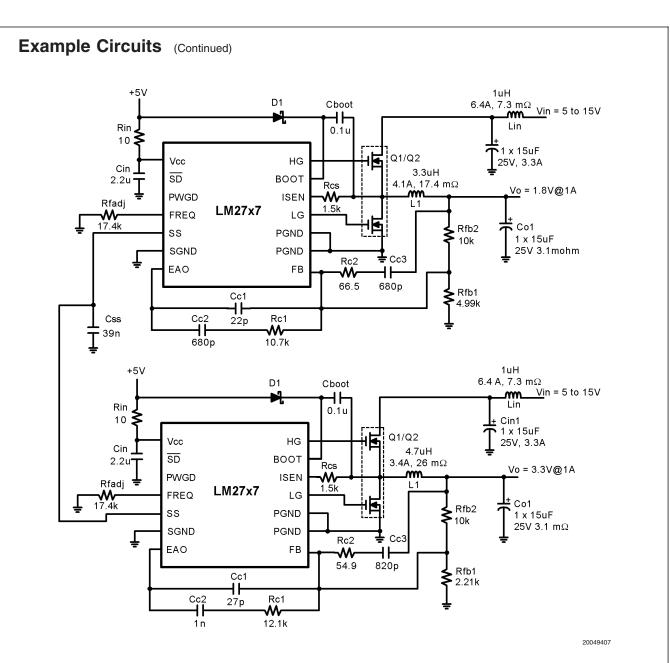


FIGURE 6. 1.8V and 3.3V, 1A, 1.4MHz, Simultaneous

The circuits in *Figure 6* are intended for ADSL applications, where the high switching frequency keeps noise out of the data transmission range. In this design, the 1.8 and 3.3V outputs come up simultaneously by using the same softstart capacitor. Because two current sources now charge the same capacitor, the capacitance must be doubled to achieve the same softstart time. (Here, 40nF is used to achieve a

5ms softstart time.) A common softstart capacitor means that, should one circuit enter current limit, the other circuit will also enter current limit. In addition, if both circuits are built with the LM2727, a UVP or OVP fault on one circuit will cause both circuits to latch off. The additional compensation components Rc2 and Cc3 are needed for the low ESR, all ceramic output capacitors, and the wide (3x) range of Vin.

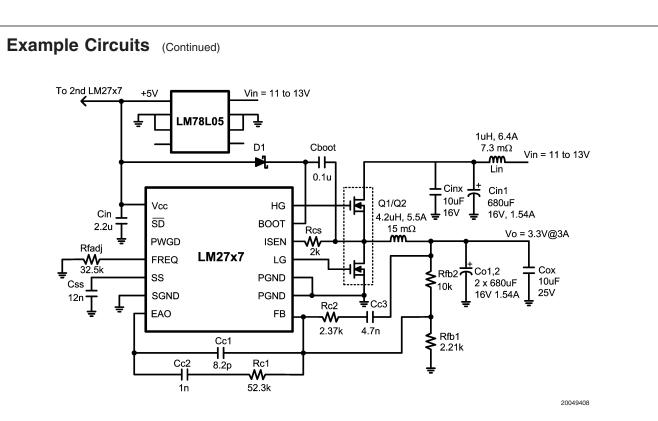


FIGURE 7. 12V Unregulated to 3.3V, 3A, 750kHz

This circuit shows the LM27x7 paired with a cost effective solution to provide the 5V chip power supply, using no extra components other than the LM78L05 regulator itself. The input voltage comes from a 'brick' power supply which does

not regulate the 12V line tightly. Additional, inexpensive 10uF ceramic capacitors (Cinx and Cox) help isolate devices with sensitive databands, such as DSL and cable modems, from switching noise and harmonics.

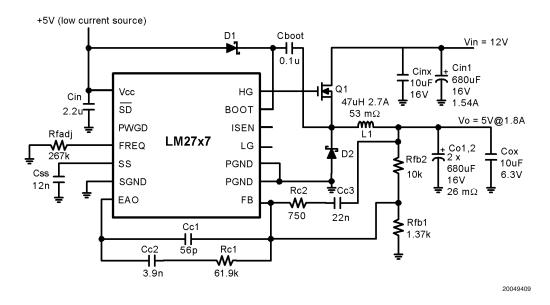


FIGURE 8. 12V to 5V, 1.8A, 100kHz

In situations where low cost is very important, the LM27x7 can also be used as an asynchronous controller, as shown in the above circuit. Although a a schottky diode in place of the bottom FET will not be as efficient, it will cost much less than the FET. The 5V at low current needed to run the LM27x7 could come from a zener diode or inexpensive regulator,

such as the one shown in *Figure 7*. Because the LM27x7 senses current in the low side MOSFET, the current limit feature will not function in an asynchronous design. The ISEN pin should be left open in this case.

LM2727/LM2737

ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
U1	LM2727	Synchronous Controller	TSSOP-14	TSSOP-14	1	NSC
Q1, Q2	Si4884DY	N-MOSFET	SO-8	30V, 4.1mΩ, 36nC	1	Vishay
L1	RLF7030T-1R5N6R1	Inductor	7.1x7.1x3.2mm	1.5μH, 6.1A 9.6mΩ	1	TDK
Cin1, Cin2	C2012X5R1J106M	MLCC	0805	10µF 6.3V	2	TDK
Cinx	C3216X7R1E105K	Capacitor	1206	1µF, 25V	1	TDK
Co1, Co2	6MV2200WG	AL-E	10mm D 20mm H	2200μF 6.3V125mΩ	2	Sanyo
Cboot	VJ1206X104XXA	Capacitor	1206	0.1µF, 25V	1	Vishay
Cin	C3216X7R1E225K	Capacitor	1206	0.1µF, 25V	1	TDK
Css	VJ1206X123KXX	Capacitor	1206	12nF, 25V	1	Vishay
Cc1	VJ1206A2R2KXX	Capacitor	1206	2.2pF 10%	1	Vishay
Cc2	VJ1206A181KXX	Capacitor	1206	180pF 10%	1	Vishay
Rin	CRCW1206100J	Resistor	1206	10Ω 5%	1	Vishay
Rfadj	CRCW12066342F	Resistor	1206	63.4kΩ 1%	1	Vishay
Rc1	CRCW12063923F	Resistor	1206	392kΩ 1%	1	Vishay
Rfb1	CRCW12061002F	Resistor	1206	10kΩ 1%	1	Vishay
Rfb2	CRCW12061002F	Resistor	1206	10kΩ 1%	1	Vishay
Rcs	CRCW1206222J	Resistor	1206	2.2kΩ 5%	1	Vishay

TABLE 2. Bill of Materials for Circuit of Figure 2(Identical to BOM for 1.5V except as noted below)

				-		
ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
L1	RLF12560T-2R7N110	Inductor	12.5x12.8x6mm	2.7μH, 14.4A 4.5mΩ	1	TDK
Co1, Co2,	10TPB100M	POSCAP	7.3x4.3x2.8mm	100µF 10V 1.9Arms	4	Sanyo
Co3, Co4	TOTEBIOON	FUSCAF	7.384.382.011111	TOOPE TOV T.SAILIS	4	Sanyo
Cc1	VJ1206A6R8KXX	Capacitor	1206	6.8pF 10%	1	Vishay
Cc2	VJ1206A271KXX	Capacitor	1206	270pF 10%	1	Vishay
Cc3	VJ1206A471KXX	Capacitor	1206	470pF 10%	1	Vishay
Rc2	CRCW12068451F	Resistor	1206	8.45kΩ 1%	1	Vishay
Rfb1	CRCW12061102F	Resistor	1206	11kΩ 1%	1	Vishay

TABLE 3. Bill of Ma	aterials for Circuit	of Figure 3
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ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
U1	LM2727	Synchronous Controller	TSSOP-14		1	NSC
Q1	Si4442DY	N-MOSFET	SO-8	30V, 4.1mΩ, @ 4.5V, 36nC	1	Vishay
Q2	Si4442DY	N-MOSFET	SO-8	30V, 4.1mΩ, @ 4.5V, 36nC	1	Vishay
D1	BAT-54	Schottky Diode	SOT-23	30V	1	Vishay
Lin	SLF12575T-1R2N8R2	Inductor	12.5x12.5x7.5mm	12μH, 8.2A, 6.9mΩ	1	Coilcraf
L1	D05022-152HC	Inductor	22.35x16.26x8mm	1.5μH, 15A,4mΩ	1	Coilcraf
Cin1, Cin2	10MV5600AX	Aluminum Electrolytic	16mm D 25mm H	5600µF10V 2.35Arms	2	Sanyo
Cinx	C3216X7R1E105K	Capacitor	1206	1µF, 25V	1	TDK
Co1, Co2, Co3	10MV5600AX	Aluminum Electrolytic	16mm D 25mm H	5600µF10V 2.35Arms	2	Sanyo
Cboot	VJ1206X104XXA	Capacitor	1206	0.1µF, 25V	1	Vishay
Cin	C3216X7R1E225K	Capacitor	1206	2.2µF, 25V	1	TDK
Css	VJ1206X123KXX	Capacitor	1206	12nF, 25V	1	Vishay

	TABLE 3. Bill of Materials for Circuit of Figure 3 (Continued)										
ID	Part Number	Туре	Size	Parameters	Qty.	Vendor					
Cc1	VJ1206A4R7KXX	Capacitor	1206	4.7pF 10%	1	Vishay					
Cc2	VJ1206A102KXX	Capacitor	1206	1nF 10%	1	Vishay					
Rin	CRCW1206100J	Resistor	1206	10Ω 5%	1	Vishay					
Rfadj	CRCW12068872F	Resistor	1206	88.7kΩ 1%	1	Vishay					
Rc1	CRCW12062293F	Resistor	1206	229kΩ 1%	1	Vishay					
Rfb1	CRCW12064991F	Resistor	1206	4.99kΩ 1%	1	Vishay					
Rfb2	CRCW12064991F	Resistor	1206	4.99kΩ 1%	1	Vishay					
Rcs	CRCW1206152J	Resistor	1206	1.5kΩ 5%	1	Vishay					

TABLE 4. Bill of Materials for Circuit of Figure 4

ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
U1	LM2727	Synchronous Controller	TSSOP-14		1	NSC
Q1/Q2	Si4826DY	Asymetric Dual N-MOSFET	SO-8	30V, 24mΩ/ 8nC Top 16.5mΩ/ 15nC	1	Vishay
L1	DO3316P-222	Inductor	12.95x9.4x 5.21mm	2.2μH, 6.1A, 12mΩ	1	Coilcraft
Cin1	10TPB100ML	POSCAP	7.3x4.3x3.1mm	100µF 10V 1.9Arms	1	Sanyo
Co1	4TPB220ML	POSCAP	7.3x4.3x3.1mm	220µF 4V 1.9Arms	1	Sanyo
Сс	C3216X7R1E105K	Capacitor	1206	1µF, 25V	1	TDK
Cin	C3216X7R1E225K	Capacitor	1206	2.2µF, 25V	1	TDK
Css	VJ1206X123KXX	Capacitor	1206	12nF, 25V	1	Vishay
Cc1	VJ1206A100KXX	Capacitor	1206	10pF 10%	1	Vishay
Cc2	VJ1206A561KXX	Capacitor	1206	560pF 10%	1	Vishay
Rin	CRCW1206100J	Resistor	1206	10Ω 5%	1	Vishay
Rfadj	CRCW12064222F	Resistor	1206	42.2kΩ 1%	1	Vishay
Rc1	CRCW12065112F	Resistor	1206	51.1kΩ 1%	1	Vishay
Rfb1	CRCW12062491F	Resistor	1206	2.49kΩ 1%	1	Vishay
Rfb2	CRCW12064991F	Resistor	1206	4.99kΩ 1%	1	Vishay
Rcs	CRCW1206272J	Resistor	1206	2.7kΩ 5%	1	Vishay

TABLE 5. Bill of Materials for Circuit of Figure 5

ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
U1	LM2727	Synchronous Controller	TSSOP-14		1	NSC
Q1	Si4884DY	N-MOSFET	SO-8	30V, 13.5mΩ, @ 4.5V 15.3nC	1	Vishay
Q2	Si4884DY	N-MOSFET	SO-8	30V, 13.5mΩ, @ 4.5V 15.3nC	1	Vishay
D1	BAT-54	Schottky Diode	SOT-23	30V	1	Vishay
Lin	P1166.102T	Inductor	7.29x7.29 3.51mm	1μH, 11A 3.7mΩ	1	Pulse
L1	P1168.102T	Inductor	12x12x4.5 mm	1μH, 11A, 3.7mΩ	1	Pulse
Cin1	10MV5600AX	Aluminum Electrolytic	16mm D 25mm H	5600µF 10V 2.35Arms	1	Sanyo
Cinx	C3216X7R1E105K	Capacitor	1206	1µF, 25V	1	TDK
Co1, Co2, Co3	16MV4700WX	Aluminum Electrolytic	12.5mm D 30mm H	4700µF 16V 2.8Arms	2	Sanyo
Cboot	VJ1206X104XXA	Capacitor	1206	0.1µF, 25V	1	Vishay
Cin	C3216X7R1E225K	Capacitor	1206	2.2µF, 25V	1	TDK
Css	VJ1206X123KXX	Capacitor	1206	12nF, 25V	1	Vishay

ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
Cc1	VJ1206A4R7KXX	Capacitor	1206	4.7pF 10%	1	Vishay
Cc2	VJ1206A681KXX	Capacitor	1206	680pF 10%	1	Vishay
Rin	CRCW1206100J	Resistor	1206	10Ω 5%	1	Vishay
Rfadj	CRCW12064992F	Resistor	1206	49.9kΩ 1%	1	Vishay
Rc1	CRCW12061473F	Resistor	1206	147kΩ 1%	1	Vishay
Rfb1	CRCW12061492F	Resistor	1206	14.9kΩ 1%	1	Vishay
Rfb2	CRCW12064991F	Resistor	1206	4.99kΩ 1%	1	Vishay
Rcs	CRCW1206332J	Resistor	1206	3.3kΩ 5%	1	Vishay

TABLE 6. Bill of Materials for Circuit of Figure 6

TABLE 0. Bill of Materials for Circuit of Figure 0										
Part Number	Туре	Size	Parameters	Qty.	Vendor					
LM2727	Synchronous	TSSOP-14		1	NSC					
	Controller									
Si4826DY	Assymetric Dual	SO-8	30V, 24mΩ/ 8nC	1	Vishay					
	N-MOSFET		Top 16.5mΩ/ 15nC							
BAT-54	Schottky Diode	SOT-23	30V	1	Vishay					
RLF7030T-1R0N64	Inductor	6.8x7.1x3.2mm	1μH, 6.4A, 7.3mΩ	1	TDK					
RLF7030T-3R3M4R1	Inductor	6.8x7.1x3.2mm	3.3μH, 4.1A, 17.4mΩ	1	TDK					
C4532X5R1E156M	MLCC	1812	15µF 25V 3.3Arms	1	Sanyo					
C4532X5R1E156M	MLCC	1812	15µF 25V 3.3Arms	1	Sanyo					
VJ1206X104XXA	Capacitor	1206	0.1µF, 25V	1	TDK					
C3216X7R1E225K	Capacitor	1206	2.2µF, 25V	1	TDK					
VJ1206X393KXX	Capacitor	1206	39nF, 25V	1	Vishay					
VJ1206A220KXX	Capacitor	1206	22pF 10%	1	Vishay					
VJ1206A681KXX	Capacitor	1206	680pF 10%	1	Vishay					
VJ1206A681KXX	Capacitor	1206	680pF 10%	1	Vishay					
CRCW1206100J	Resistor	1206	10Ω 5%	1	Vishay					
CRCW12061742F	Resistor	1206	17.4kΩ 1%	1	Vishay					
CRCW12061072F	Resistor	1206	10.7kΩ 1%	1	Vishay					
CRCW120666R5F	Resistor	1206	66.5Ω 1%	1	Vishay					
CRCW12064991F	Resistor	1206	4.99kΩ 1%	1	Vishay					
CRCW12061002F	Resistor	1206	10kΩ 1%	1	Vishay					
CRCW1206152J	Resistor	1206	1.5kΩ 5%	1	Vishay					
	LM2727 Si4826DY BAT-54 RLF7030T-1R0N64 RLF7030T-3R3M4R1 C4532X5R1E156M C4532X5R1E156M VJ1206X104XXA C3216X7R1E225K VJ1206A393KXX VJ1206A681KXX VJ1206A681KXX VJ1206A681KXX CRCW1206100J CRCW12061072F CRCW12061072F CRCW12064991F CRCW12061002F	Part NumberTypeLM2727Synchronous ControllerSi4826DYAssymetric Dual N-MOSFETBAT-54Schottky DiodeRLF7030T-1R0N64InductorRLF7030T-3R3M4R1InductorC4532X5R1E156MMLCCC4532X5R1E156MMLCCVJ1206X104XXACapacitorC3216X7R1E225KCapacitorVJ1206A393KXXCapacitorVJ1206A681KXXCapacitorVJ1206A681KXXCapacitorVJ1206A681KXXCapacitorCRCW1206100JResistorCRCW12061072FResistorCRCW12064991FResistorCRCW12061002FResistor	Part NumberTypeSizeLM2727Synchronous ControllerTSSOP-14Si4826DYAssymetric Dual N-MOSFETSO-8BAT-54Schottky DiodeSOT-23RLF7030T-1R0N64Inductor6.8x7.1x3.2mmRLF7030T-3R3M4R1Inductor6.8x7.1x3.2mmC4532X5R1E156MMLCC1812VJ1206X104XXACapacitor1206C3216X7R1E225KCapacitor1206VJ1206A220KXXCapacitor1206VJ1206A681KXXCapacitor1206VJ1206A681KXXCapacitor1206CRCW1206100JResistor1206CRCW12061072FResistor1206CRCW12064991FResistor1206CRCW12061002FResistor1206CRCW12061002FResistor1206CRCW12061002FResistor1206CRCW12061002FResistor1206CRCW12061002FResistor1206CRCW12061002FResistor1206	Part Number Type Size Parameters LM2727 Synchronous Controller TSSOP-14 Si4826DY Assymetric Dual N-MOSFET SO-8 30V, 24mΩ/ 8nC Top 16.5mΩ/ 15nC BAT-54 Schottky Diode SOT-23 30V RLF7030T-1R0N64 Inductor 6.8x7.1x3.2mm 1µH, 6.4A, 7.3mΩ RLF7030T-3R3M4R1 Inductor 6.8x7.1x3.2mm 3.3µH, 4.1A, 17.4mΩ C4532X5R1E156M MLCC 1812 15µF 25V 3.3Arms C4532X5R1E156M MLCC 1812 15µF 25V 3.3Arms VJ1206X104XXA Capacitor 1206 0.1µF, 25V C3216X7R1E225K Capacitor 1206 39nF, 25V VJ1206A393KXX Capacitor 1206 39nF, 25V VJ1206A681KXX Capacitor 1206 680pF 10% VJ1206A681KXX Capacitor 1206 10Ω2 5% CRCW1206100J Resistor 1206 10Ω2 5% CRCW120610J Resistor 1206 10.7kΩ 1% CRCW120660R5F Resistor 1206	Part Number Type Size Parameters Qty. LM2727 Synchronous Controller TSSOP-14 1 1 Si4826DY Assymetric Dual N-MOSFET SO-8 30V, 24mΩ/ 8nC 1 BAT-54 Schottky Diode SO-23 30V 1 RLF7030T-1R0N64 Inductor 6.8x7.1x3.2mm 1µH, 6.4A, 7.3mΩ 1 RLF7030T-3R3M4R1 Inductor 6.8x7.1x3.2mm 3.3µH, 4.1A, 17.4mΩ 1 C4532X5R1E156M MLCC 1812 15µF 25V 3.3Arms 1 VJ1206X104XXA Capacitor 1206 0.1µF, 25V 1 VJ1206X393KXX Capacitor 1206 39nF, 25V 1 VJ1206A220KXX Capacitor 1206 680pF 10% 1 VJ1206A681KXX Capacitor 1206 680pF 10% 1 VJ1206A681KXX Capacitor 1206 10Ω 5% 1 VJ1206A681KXX Capacitor 1206 680pF 10% 1 VJ1206A681KXX Capacitor 1206 10Ω 5%					

TABLE 7. Bill of Materials for 3.3V Circuit of *Figure 6* (Identical to BOM for 1.8V except as noted below)

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ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
L1	RLF7030T-4R7M3R4	Inductor	6.8x7.1x 3.2mm	4.7μH, 3.4A, 26mΩ	1	TDK
Cc1	VJ1206A270KXX	Capacitor	1206	27pF 10%	1	Vishay
Cc2	VJ1206X102KXX	Capacitor	1206	1nF 10%	1	Vishay
Cc3	VJ1206A821KXX	Capacitor	1206	820pF 10%	1	Vishay
Rc1	CRCW12061212F	Resistor	1206	12.1kΩ 1%	1	Vishay
Rc2	CRCW12054R9F	Resistor	1206	54.9Ω 1%	1	Vishay
Rfb1	CRCW12062211F	Resistor	1206	2.21kΩ 1%	1	Vishay
Rfb2	CRCW12061002F	Resistor	1206	10kΩ 1%	1	Vishay

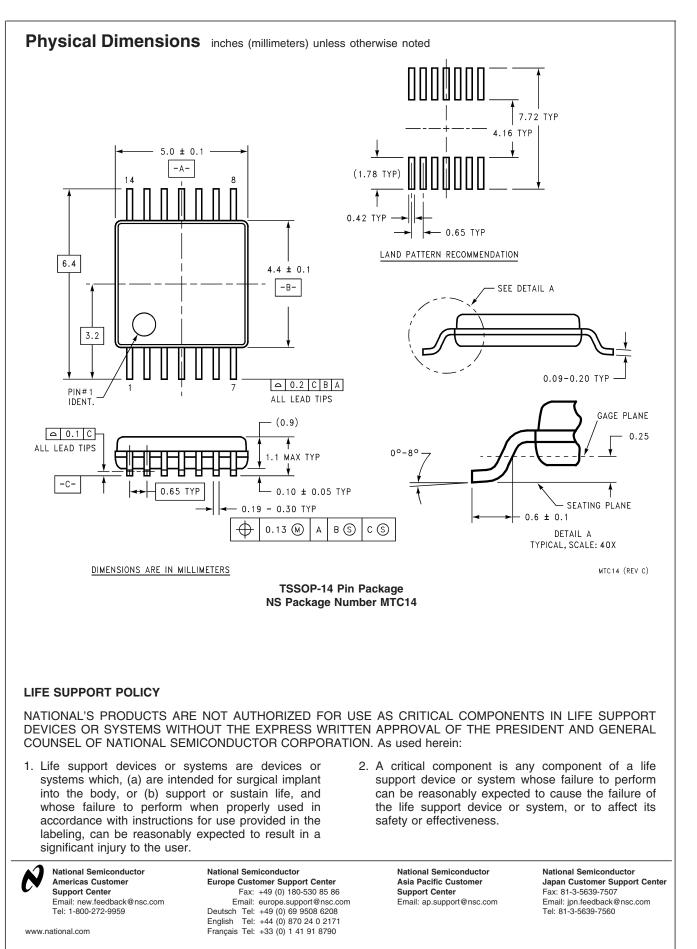
TABLE 8. Bill of Materials for Circu	it of Figure 7
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ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
U1	LM2727	Synchronous Controller	TSSOP-14		1	NSC

ID	Part Number	Туре	Size	Parameters	Qty.	Vendor
U2	LM78L05	Voltage Regulator	SO-8		1	NSC
Q1/Q2	Si4826DY	Assymetric Dual N-MOSFET	SO-8	30V, 24mΩ/ 8nC Top 16.5mΩ/ 15nC	1	Vishay
D1	BAT-54	Schottky Diode	SOT-23	30V	1	Vishay
Lin	RLF7030T-1R0N64	Inductor	6.8x7.1x3.2mm	1μH, 6.4A, 7.3mΩ	1	TDK
L1	SLF12565T-4R2N5R5	Inductor	12.5x12.5x6.5mm	$4.2\mu H$, $5.5A$, $15m\Omega$	1	TDK
Cin1	16MV680WG	AI-E	D: 10mm L: 12.5mm	680µF 16V 3.4Arms	1	Sanyo
Cinx	C3216X5R1C106M	MLCC	1210	10µF 16V 3.4Arms	1	TDK
Co1 Co2	16MV680WG	MLCC	1812	15µF 25V 3.3Arms	1	Sanyo
Cox	C3216X5R10J06M	MLCC	1206	10µF 6.3V 2.7A		TDK
Cboot	VJ1206X104XXA	Capacitor	1206	0.1µF, 25V	1	Vishay
Cin	C3216X7R1E225K	Capacitor	1206	2.2µF, 25V	1	TDK
Css	VJ1206X123KXX	Capacitor	1206	12nF, 25V	1	Vishay
Cc1	VJ1206A8R2KXX	Capacitor	1206	8.2pF 10%	1	Vishay
Cc2	VJ1206X102KXX	Capacitor	1206	1nF 10%	1	Vishay
Cc3	VJ1206X472KXX	Capacitor	1206	4.7nF 10%	1	Vishay
Rfadj	CRCW12063252F	Resistor	1206	32.5kΩ 1%	1	Vishay
Rc1	CRCW12065232F	Resistor	1206	52.3kΩ 1%	1	Vishay
Rc2	CRCW120662371F	Resistor	1206	2.37Ω 1%	1	Vishay
Rfb1	CRCW12062211F	Resistor	1206	2.21kΩ 1%	1	Vishay
Rfb2	CRCW12061002F	Resistor	1206	10kΩ 1%	1	Vishay
Rcs	CRCW1206202J	Resistor	1206	2kΩ 5%	1	Vishay

TABLE 9. Bill of Materials for Circuit of Figure 8

ID	Part Number	Туре	Size	Parameters	Qty.	Vendo
U1	LM2727	Synchronous	TSSOP-14		1	NSC
		Controller				
Q1	Si4894DY	N-MOSFET	SO-8	30V, 15mΩ, 11.5nC	1	Vishay
D2	MBRS330T3	Schottky Diode	SO-8	30V, 3A	1	ON
L1	SLF12565T-470M2R4	Inductor	12.5x12.8x 4.7mm	47μH, 2.7A 53m Ω	1	TDK
D1	MBR0520	Schottky Diode	1812	20V 0.5A	1	ON
Cin1	16MV680WG	AI-E	1206	680µF, 16V, 1.54Arms	1	Sanyo
Cinx	C3216X5R1C106M	MLCC	1206	10µF, 16V, 3.4Arms	1	TDK
Co1, Co2	16MV680WG	AI-E	D: 10mm L:	680μF 16V 26mΩ	2	Sanyo
			12.5mm			
Cox	C3216X5R10J06M	MLCC	1206	10µF, 6.3V 2.7A	1	TDK
Cboot	VJ1206X104XXA	Capacitor	1206	0.1µF, 25V	1	Vishay
Cin	C3216X7R1E225K	Capacitor	1206	2.2µF, 25V	1	TDK
Css	VJ1206X123KXX	Capacitor	1206	12nF, 25V	1	Vishay
Cc1	VJ1206A561KXX	Capacitor	1206	56pF 10%	1	Vishay
Cc2	VJ1206X392KXX	Capacitor	1206	3.9nF 10%	1	Vishay
Cc3	VJ1206X223KXX	Capacitor	1206	22nF 10%	1	Vishay
Rfadj	CRCW12062673F	Resistor	1206	267kΩ 1%	1	Vishay
Rc1	CRCW12066192F	Resistor	1206	61.9kΩ 1%	1	Vishay
Rc2	CRCW12067503F	Resistor	1206	750kΩ 1%	1	Vishay
Rfb1	CRCW12061371F	Resistor	1206	1.37kΩ 1%	1	Vishay
Rfb2	CRCW12061002F	Resistor	1206	10kΩ 1%	1	Vishay
Rcs	CRCW1206122F	Resistor	1206	1.2kΩ 5%	1	Vishay



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